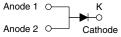


Vishay General Semiconductor

Surface-Mount ESD Capability Rectifiers



SE10DX



ADDITIONAL RESOURCES



| PRIMARY CHARACTERISTICS | | | | | |
|---|----------------------------|--|--|--|--|
| I _{F(AV)} | 10 A | | | | |
| V _{RRM} | 100 V, 200 V, 400 V, 600 V | | | | |
| I _{FSM} | 110 A | | | | |
| V_F at I_F = 10 A (T_A = 125 °C) | 0.96 V | | | | |
| I _R | 15 µA | | | | |
| T _J max. | 175 °C | | | | |
| Package | SMPD (TO-263AC) | | | | |
| Circuit configuration | Single | | | | |

FEATURES

- Very low profile typical height of 1.7 mm
- Ideal for automated placement
- Oxide planar chip junction
- Low forward voltage drop
- ESD capability
- AEC-Q101 qualified
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

General purpose, power line polarity protection, in both consumer and automotive applications.

MECHANICAL DATA

Case: SMPD (TO-263AC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: as marked

| MAXIMUM RATINGS ($T_A = 25 \text{ °C}$ unless otherwise noted) | | | | | | |
|--|-----------------------------------|-------------|--------|--------|--------|------|
| PARAMETER | SYMBOL | SE10DB | SE10DD | SE10DG | SE10DJ | UNIT |
| Maximum repetitive peak reverse voltage V _{RRM} 100 200 400 600 | | 600 | V | | | |
| Maximum DC forward current | I _F ⁽¹⁾ | 10 | | | | А |
| Maximum DC forward current | I _F ⁽²⁾ | 3.0 | | | | |
| Peak forward surge current 10 ms single half sine-wave superimposed on rated load | I _{FSM} | 110 | | А | | |
| Operating junction and storage temperature range | T _J , T _{STG} | -55 to +175 | | | °C | |

Notes

⁽¹⁾ With heatsink

⁽²⁾ Free air, mounted on recommended copper pad area

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1

Document Number: 89983



RoHS

COMPLIANT



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| ELECTRICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted) | | | | | | | |
|---|---|---|-------------------------------|------|------|------|--|
| PARAMETER | TEST CONDITIONS | | SYMBOL | TYP. | MAX. | UNIT | |
| Instantaneous forward voltage | I _F = 5 A | – T _A = 25 °C | | 0.95 | - | V | |
| | I _F = 10 A | | V _E (1) | 1.04 | 1.15 | | |
| | I _F = 5 A | - T _A = 125 °C | VF | 0.85 | - | | |
| | I _F = 10 A | | | 0.96 | 1.10 | | |
| Reverse current | Rated V _R | T _A = 25 °C T _A = 125 °C | I _B ⁽²⁾ | - | 15 | μA | |
| | naleu v _R | | 'R \-/ | 22 | 150 | | |
| Typical reverse recovery time | $I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$ | | t _{rr} | 3000 | - | ns | |
| Typical junction capacitance | 4.0 V, 1 MHz | | CJ | 67 | - | pF | |

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

⁽²⁾ Pulse test: Pulse width \leq 40 ms

| THERMAL CHARACTERISTICS ($T_A = 25$ °c unless otherwise noted) | | | | | | |
|--|-------------------------|---------------------------------------|--|--|------|------|
| PARAMETER | SYMBOL | IBOL SE10DB SE10DD SE10DG SE10DJ UNIT | | | | |
| Typical thermal resistance | R _{0JA} (1)(2) | 60 | | | | °C/W |
| | 1.6 | | | | 0/10 | |

Notes

⁽¹⁾ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

⁽²⁾ Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance $R_{\theta JA}$ - junction to ambient

⁽³⁾ With infinite heatsink

| IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS (T _A = 25 °C unless otherwise noted) | | | | | | |
|--|---------------------------------|--------------------------------|--------|-------|--------|--|
| STANDARD | TEST TYPE | TEST CONDITIONS | SYMBOL | CLASS | VALUE | |
| AEC-Q101-001 | Human body model (contact mode) | C = 100 pF, R = 1.5 k Ω | Vc | H3B | > 8 kV | |

| ORDERING INFORMATION (Example) | | | | | | |
|--------------------------------|----------------------------|--------------------|---------------------------|------------------|------------------------------------|--|
| STANDARD | PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE | |
| SMPD (TO-263AC) | SE10DJ-M3/I | 0.54 | I | 2000/reel | 13" diameter plastic tape and reel | |
| SMPD (TO-263AC) | SE10DJHM3/I ⁽¹⁾ | 0.54 | I | 2000/reel | 13" diameter plastic tape and reel | |

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES ($T_A = 25 \text{ °C}$ unless otherwise noted)

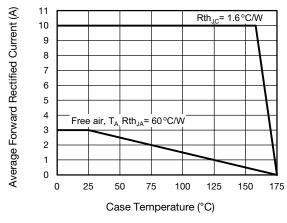


Fig. 1 - Forward Current Derating Curve

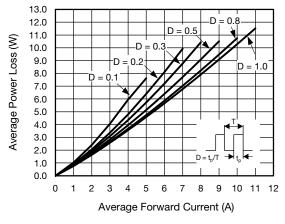
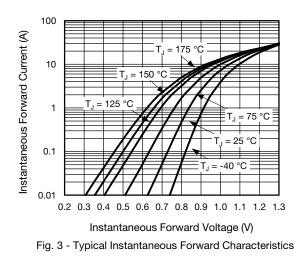


Fig. 2 - Forward Power Loss Characteristics



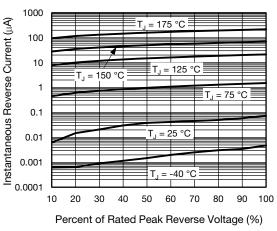
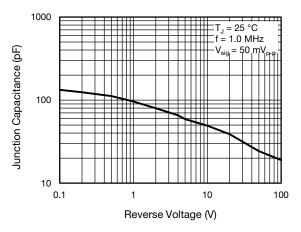


Fig. 4 - Typical Reverse Leakage Characteristics





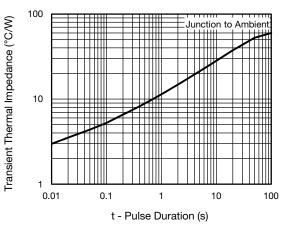


Fig. 6 - Typical Transient Thermal Impedance

Revision: 26-Feb-2020

3

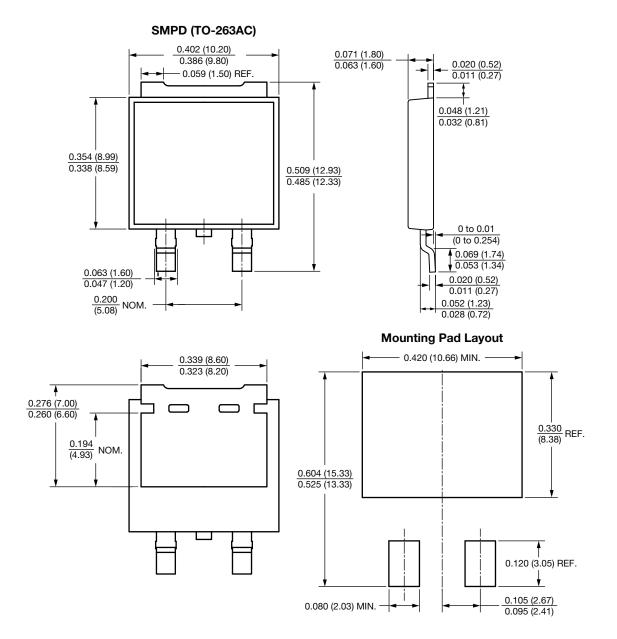
Document Number: 89983

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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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